



SRI LANKA

PATENT

To All to Whom These Presents Shall Come.

Whereas, there has been presented to the Director General of Intellectual Property an application for the grant of a patent for an invention as described, shown and claimed in the documents annexed and attached hereto, and made part hereof,

Whereas, the application is in compliance with all the requirements of the Intellectual Property Act No. 36 of 2003 and Regulations made thereunder,

A patent is hereby granted to the person whose name, address and other relevant information are given hereunder and the patentee shall have for a period of twenty years from the filing date of the application for the patent, subject to the provisions of the Intellectual Property Act No. 36 of 2003, the exclusive rights to exploit the patented invention, to assign or transmit the patent and to conclude licence contracts relating to the patent.

The patentee who intends to keep the patent in force is required to renew the patent at the expiration of two years from the date of the grant of the patent and each succeeding year during the term of the patent.

In witness whereof I have hereunto caused the seal of the National Intellectual Property Office of Sri Lanka to be affixed in the city of Colombo on this

**First day of September of the year
Two Thousand and Sixteen**



[Signature]

Director General of Intellectual Property

National Intellectual Property Office of Sri Lanka

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Name (s) and Address (es) of the owner of patent:

*Dr. Rangika Umesh Halwatura
No: 2A, Lesly Perera Mawatha, Kaluthara North and
Mr. Manamendra Patabendige Kasun Chinthaka Nandapala
96, Eriyagoda Estate, Pallawa-Dampitiya Road, Hanhamunawa, Maspotha.*

Name (s) and Address (es) of the Inventor (s) :

*Dr. Rangika Umesh Halwatura (whose legal address is No: 2A, Lesly Perera Mawatha, Kaluthara North) and
Mr. Manamendra Patabendige Kasun Chinthaka Nandapala (whose legal address is 96, Eriyagoda Estate, Pallawa-Dampitiya Road, Hanhamunawa, Maspotha).*

Title of the Invention:

A HEAT INSULATION SYSTEM FOR FLAT ROOF SLABS

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